

## TP3054-X, TP3057-X

# Extended Temperature Serial Interface CODEC/Filter COMBO® Family

## **General Description**

The TP3054, TP3057 family consists of  $\mu$ -law and A-law monolithic PCM CODEC/filters utilizing the A/D and D/A conversion architecture shown in *Figure 1*, and a serial PCM interface. The devices are fabricated using National's advanced double-poly CMOS process (microCMOS).

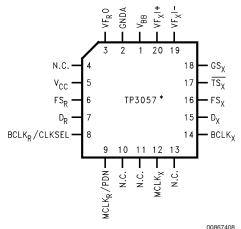
The encode portion of each device consists of an input gain adjust amplifier, an active RC pre-filter which eliminates very high frequency noise prior to entering a switched-capacitor band-pass filter that rejects signals below 200 Hz and above 3400 Hz. Also included are auto-zero circuitry and a companding coder which samples the filtered signal and encodes it in the companded µ-law or A-law PCM format. The decode portion of each device consists of an expanding decoder, which reconstructs the analog signal from the companded  $\mu$ -law or A-law code, a low-pass filter which corrects for the sin x/x response of the decoder output and rejects signals above 3400 Hz followed by a single-ended power amplifier capable of driving low impedance loads. The devices require two 1.536 MHz, 1.544 MHz or 2.048 MHz transmit and receive master clocks, which may be asynchronous; transmit and receive bit clocks, which may vary from 64 kHz to 2.048 MHz; and transmit and receive frame sync pulses. The timing of the frame sync pulses and PCM data is compatible with both industry standard formats.

### **Features**

- -40°C to +85°C operation
- Complete CODEC and filtering system (COMBO) including:
  - Transmit high-pass and low-pass filtering
  - Receive low-pass filter with sin x/x correction
  - Active RC noise filters
- μ-law or A-law compatible COder and DECoder
- Internal precision voltage reference
- Serial I/O interface
- Internal auto-zero circuitry
- µ-law, 16-pin—TP3054
- A-law, 16-pin—TP3057
- Designed for D3/D4 and CCITT applications
- ±5V operation
- Low operating power—typically 50 mW
- Power-down standby mode—typically 3 mW
- Automatic power-down
- TTL or CMOS compatible digital interfaces
- Maximizes line interface card circuit density
- Dual-In-Line or PCC surface mount packages
- See also AN-370, "Techniques for Designing with CODEC/Filter COMBO Circuits"

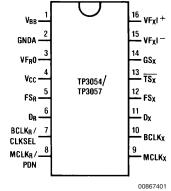
## **Connection Diagrams**

#### **Plastic Chip Carriers**



Top View
Order Number TP3057V-X
NS Package Number V20A

#### **Dual-In-Line Package**



Top View
Order Number TP3054N-X
NS Package Number N16E
Order Number TP3054WM-X
NS Package Number M16B

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# **Block Diagram**

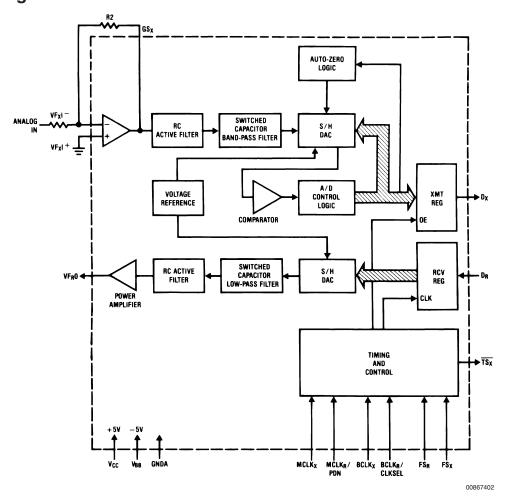


FIGURE 1.

Symbol

**Function** 

		ions	

$\mathbf{Symbol} \\ \mathbf{V}_{\mathrm{BB}}$	Function  Negative power supply pin. $V_{BB} = -5V \pm 5\%$ .	BCLK <sub>R</sub> /CLKSEL	The bit clock which shifts data into D <sub>R</sub> after the FS <sub>R</sub> leading edge. May vary from 64 kHz to 2.048 MHz.  Alternatively, may be a logic input
GNDA	Analog ground. All signals are referenced to this pin.		which selects either 1.536 MHz/1.544 MHz or 2.048 MHz for master clock in
VF <sub>R</sub> O	Analog output of the receive power amplifier.		synchronous mode and BCLK <sub>X</sub> is used for both transmit and receive directions
$V_{CC}$	Positive power supply pin. $V_{CC} = +5V \pm 5\%$ .	MCLK <sub>B</sub> /PDN	(see <i>Table 1</i> ).  Receive master clock. Must be 1.536
FS <sub>R</sub>	Receive frame sync pulse which enables BCLK <sub>R</sub> to shift PCM data into D <sub>R</sub> . FS <sub>R</sub> is an 8 kHz pulse train. See Figure 2 and Figure 3 for timing details.	WOLK <sub>R</sub> /F DIV	MHz, 1.544 MHz or 2.048 MHz. May be asynchronous with MCLK <sub>X</sub> , but should be synchronous with MCLK <sub>X</sub> for best performance. When MCLK <sub>R</sub> is
D <sub>R</sub>	Receive data input. PCM data is shifted into $D_R$ following the $FS_R$ leading edge.		connected continuously low, $\mathrm{MCLK}_{\mathrm{X}}$ is selected for all internal timing. When $\mathrm{MCLK}_{\mathrm{R}}$ is connected continuously high, the device is powered down.

## Pin Descriptions (Continued)

S	Symbol	Function
MCL	<b>≺</b> <sub>X</sub>	Transmit master clock. Must be 1.536 MHz, 1.544 MHz or 2.048 MHz. May be asynchronous with MCLK <sub>R</sub> . Best performance is realized from synchronous operation.
$FS_X$		Transmit frame sync pulse input which enables $BCLK_X$ to shift out the PCM data on $D_X$ . $FS_X$ is an 8 kHz pulse train, see <i>Figure 2</i> and <i>Figure 3</i> for timing details.
BCL	×χ.	The bit clock which shifts out the PCM data on $D_x$ . May vary from 64 kHz to 2.048 MHz, but must be synchronous with MCLK <sub>x</sub> .
$D_X$		The TRI-STATE® PCM data output which is enabled by FS <sub>x</sub> .
$\overline{TS_X}$		Open drain output which pulses low during the encoder time slot.
GS <sub>X</sub>		Analog output of the transmit input amplifier. Used to externally set gain.
VF <sub>X</sub> I	-	Inverting input of the transmit input amplifier.
۷F <sub>X</sub> I <sup>-</sup>	-	Non-inverting input of the transmit input amplifier.

## **Functional Description**

#### **POWER-UP**

When power is first applied, power-on reset circuitry initializes the COMBO and places it into a power-down state. All non-essential circuits are deactivated and the  $D_{\rm X}$  and  $VF_{\rm R}O$  outputs are put in high impedance states. To power-up the device, a logical low level or clock must be applied to the MCLK\_R/PDN pin and FS\_X and/or FS\_R pulses must be present. Thus, 2 power-down control modes are available. The first is to pull the MCLK\_R/PDN pin high; the alternative is to hold both FS\_X and FS\_R inputs continuously low—the device will power-down approximately 1 ms after the last FS\_X or FS\_R pulse. Power-up will occur on the first FS\_X or FS\_R pulse. The TRI-STATE PCM data output,  $D_{\rm X}$ , will remain in the high impedance state until the second FS\_x pulse.

#### SYNCHRONOUS OPERATION

For synchronous operation, the same master clock and bit clock should be used for both the transmit and receive directions. In this mode, a clock must be applied to  $\mathsf{MCLK}_\mathsf{X}$  and the  $\mathsf{MCLK}_\mathsf{R}/\mathsf{PDN}$  pin can be used as a power-down control. A low level on  $\mathsf{MCLK}_\mathsf{R}/\mathsf{PDN}$  powers up the device and a high level powers down the device. In either case,  $\mathsf{MCLK}_\mathsf{X}$  will be selected as the master clock for both the transmit and receive circuits. A bit clock must also be applied to  $\mathsf{BCLK}_\mathsf{X}$  and the  $\mathsf{BCLK}_\mathsf{R}/\mathsf{CLKSEL}$  can be used to select the proper internal divider for a master clock of 1.536 MHz, 1.544 MHz or 2.048 MHz. For 1.544 MHz operation, the device automatically compensates for the 193rd clock pulse each frame.

With a fixed level on the BCLK $_{\rm R}/{\rm CLKSEL}$  pin, BCLK $_{\rm X}$  will be selected as the bit clock for both the transmit and receive directions. Table 1 indicates the frequencies of operation which can be selected, depending on the state of BCLK $_{\rm R}/{\rm CLKSEL}$ . In this synchronous mode, the bit clock, BCLK $_{\rm X}$ , may be from 64 kHz to 2.048 MHz, but must be synchronous with MCLK $_{\rm X}$ .

Each FS $_{\rm X}$  pulse begins the encoding cycle and the PCM data from the previous encode cycle is shifted out of the enabled D $_{\rm X}$  output on the positive edge of BCLK $_{\rm X}$ . After 8 bit clock periods, the TRI-STATE D $_{\rm X}$  output is returned to a high impedance state. With an FS $_{\rm R}$  pulse, PCM data is latched via the D $_{\rm R}$  input on the negative edge of BCLK $_{\rm X}$  (or BCLK $_{\rm R}$  if running). FS $_{\rm X}$  and FS $_{\rm R}$  must be synchronous with MCLK $_{\rm X/R}$ .

**TABLE 1. Selection of Master Clock Frequencies** 

	Master Clock							
BCLK <sub>R</sub> /CLKSEL	Frequency Selected							
	TP3057	TP3054						
Clocked	2.048 MHz	1.536 MHz or						
		1.544 MHz						
0	1.536 MHz or	2.048 MHz						
	1.544 MHz							
1	2.048 MHz	1.536 MHz or						
		1.544 MHz						

#### **ASYNCHRONOUS OPERATION**

For asynchronous operation, separate transmit and receive clocks may be applied.  $MCLK_X$  and  $MCLK_R$  must be 2.048 MHz for the TP3057, or 1.536 MHz, 1.544 MHz for the TP3054, and need not be synchronous. For best transmission performance, however, MCLK<sub>B</sub> should be synchronous with MCLK<sub>x</sub>, which is easily achieved by applying only static logic levels to the MCLK<sub>R</sub>/PDN pin. This will automatically connect  $\mathsf{MCLK}_\mathsf{X}$  to all internal  $\mathsf{MCLK}_\mathsf{R}$  functions (see Pin Description). For 1.544 MHz operation, the device automatically compensates for the 193rd clock pulse each frame. FS<sub>x</sub> starts each encoding cycle and must be synchronous with MCLKx and BCLKx. FSB starts each decoding cycle and must be synchronous with BCLK<sub>R</sub>. BCLK<sub>R</sub> must be a clock, the logic levels shown in Table 1 are not valid in asynchronous mode.  $\operatorname{BCLK}_X$  and  $\operatorname{BCLK}_R$  may operate from 64 kHz to 2.048 MHz.

#### SHORT FRAME SYNC OPERATION

The COMBO can utilize either a short frame sync pulse or a long frame sync pulse. Upon power initialization, the device assumes a short frame mode. In this mode, both frame sync pulses,  $FS_{\rm X}$  and  $FS_{\rm R}$ , must be one bit clock period long, with timing relationships specified in Figure 2. With  $FS_{\rm X}$  high during a falling edge of BCLK\_X, the next rising edge of BCLK\_X enables the  $D_{\rm X}$  TRI-STATE output buffer, which will output the sign bit. The following seven rising edges clock out the remaining seven bits, and the next falling edge disables the  $D_{\rm X}$  output. With  $FS_{\rm R}$  high during a falling edge of BCLK\_R (BCLK\_X in synchronous mode), the next falling edge of BCLK\_R latches in the sign bit. The following seven falling edges latch in the seven remaining bits. All four devices may utilize the short frame sync pulse in synchronous or asynchronous operating mode.

## Functional Description (Continued)

#### LONG FRAME SYNC OPERATION

To use the long frame mode, both the frame sync pulses, FS<sub>X</sub> and FS<sub>B</sub>, must be three or more bit clock periods long, with timing relationships specified in Figure 3. Based on the transmit frame sync, FSx, the COMBO will sense whether short or long frame sync pulses are being used. For 64 kHz operation, the frame sync pulse must be kept low for a minimum of 160 ns. The  $\mathrm{D}_{\mathrm{X}}$  TRI-STATE output buffer is enabled with the rising edge of FSX or the rising edge of BCLK<sub>x</sub>, whichever comes later, and the first bit clocked out is the sign bit. The following seven BCLK<sub>X</sub> rising edges clock out the remaining seven bits. The D<sub>x</sub> output is disabled by the falling  $\operatorname{BCLK}_X$  edge following the eighth rising edge, or by FS<sub>x</sub> going low, whichever comes later. A rising edge on the receive frame sync pulse, FS<sub>R</sub>, will cause the PCM data at D<sub>B</sub> to be latched in on the next eight falling edges of BCLK<sub>B</sub> (BCLK<sub>x</sub> in synchronous mode). All four devices may utilize the long frame sync pulse in synchronous or asynchronous

In applications where the LSB bit is used for signalling, with  $FS_R$  two bit clock periods long, the decoder will interpret the lost LSB as "1/2" to minimize noise and distortion.

#### TRANSMIT SECTION

The transmit section input is an operational amplifier with provision for gain adjustment using two external resistors, see *Figure 4*. The low noise and wide bandwidth allow gains in excess of 20 dB across the audio passband to be realized. The op amp drives a unity-gain filter consisting of RC active

pre-filter, followed by an eighth order switched-capacitor bandpass filter clocked at 256 kHz. The output of this filter directly drives the encoder sample-and-hold circuit. The A/D is of companding type according to  $\mu$ -law (TP3054) or A-law (TP3057) coding conventions. A precision voltage reference is trimmed in manufacturing to provide an input overload (t\_MAX) of nominally 2.5V peak (see table of Transmission Characteristics). The FS\_x frame sync pulse controls the sampling of the filter output, and then the successive-approximation encoding cycle begins. The 8-bit code is then loaded into a buffer and shifted out through  $D_X$  at the next FS\_x pulse. The total encoding delay will be approximately 165  $\mu$ s (due to the transmit filter) plus 125  $\mu$ s (due to encoding delay), which totals 290  $\mu$ s. Any offset voltage due to the filters or comparator is cancelled by sign bit integration.

#### **RECEIVE SECTION**

The receive section consists of an expanding DAC which drives a fifth order switched-capacitor low pass filter clocked at 256 kHz. The decoder is A-law (TP3057) or  $\mu$ -law (TP3054) and the 5th order low pass filter corrects for the sin x/x attenuation due to the 8 kHz sample/hold. The filter is then followed by a 2nd order RC active post-filter/power amplifier capable of driving a  $600\Omega$  load to a level of 7.2 dBm. The receive section is unity-gain. Upon the occurrence of FS $_{\rm R}$ , the data at the D $_{\rm R}$  input is clocked in on the falling edge of the next eight BCLK $_{\rm R}$  (BCLK $_{\rm X}$ ) periods. At the end of the decoder time slot, the decoding cycle begins, and 10  $\mu$ s later the decoder DAC output is updated. The total decoder delay is ~10  $\mu$ s (decoder update) plus 110  $\mu$ s (filter delay) plus 62.5  $\mu$ s (½ frame), which gives approximately 180  $\mu$ s.

## **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

 $V_{CC}$  to GNDA 7V  $V_{BB}$  to GNDA -7V

Voltage at any Analog Input

or Output  $V_{CC}$ +0.3V to  $V_{BB}$ -0.3V

Voltage at any Digital Input or

Output  $V_{CC}$ +0.3V to GNDA-0.3V Operating Temperature Range  $-55^{\circ}$ C to + 125 $^{\circ}$ C Storage Temperature Range  $-65^{\circ}$ C to +150 $^{\circ}$ C Lead Temperature

(Soldering, 10 sec.) 300°C

## **Electrical Characteristics**

Unless otherwise noted, limits printed in **BOLD** characters are guaranteed for  $V_{CC}$  = +5.0V ±5%,  $V_{BB}$  = -5.0V ±5%;  $T_A$  = -40°C to +85°C by correlation with 100% electrical testing at  $T_A$  = 25°C. All other limits are assured by correlation with other production tests and/or product design and characterization. All signals referenced to GNDA. Typicals specified at  $V_{CC}$  = +5.0V,  $V_{BB}$  = -5.0V,  $V_{AB}$  = 25°C.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
DIGITAL I	NTERFACE					
$V_{IL}$	Input Low Voltage				0.6	V
$V_{IH}$	Input High Voltage		2.2			V
V <sub>OL</sub>	Output Low Voltage	D <sub>X</sub> , I <sub>L</sub> =3.2 mA			0.4	V
		SIG <sub>R</sub> , I <sub>L</sub> =1.0 mA			0.4	V
		$\overline{TS_{X}}$ , $I_{L}$ =3.2 mA, Open Drain			0.4	V
$V_{OH}$	Output High Voltage	$D_X$ , $I_H$ =-3.2 mA	2.4			V
		SIG <sub>R</sub> , I <sub>H</sub> =-1.0 mA	2.4			V
$I_{IL}$	Input Low Current	GNDA≤V <sub>IN</sub> ≤V <sub>IL</sub> , All Digital Inputs	-10		10	μΑ
I <sub>IH</sub>	Input High Current	$V_{IH} \leq V_{IN} \leq V_{CC}$	-10		10	μΑ
l <sub>oz</sub>	Output Current in High Impedance	D <sub>X</sub> , GNDA≤V <sub>O</sub> ≤V <sub>CC</sub>	-10		10	μΑ
	State (TRI-STATE)					
ANALOG	INTERFACE WITH TRANSMIT INPUT	AMPLIFIER (ALL DEVICES)		•	•	
I <sub>I</sub> XA	Input Leakage Current	–2.5V≤V≤+2.5V, VF <sub>X</sub> I <sup>+</sup> or VF <sub>X</sub> I <sup>-</sup>	-200		200	nA
R <sub>I</sub> XA	Input Resistance	–2.5V≤V≤+2.5V, VF <sub>X</sub> I <sup>+</sup> or VF <sub>X</sub> I <sup>-</sup>	10			MΩ
R <sub>O</sub> XA	Output Resistance	Closed Loop, Unity Gain		1 3		Ω
R <sub>L</sub> XA	Load Resistance	GS <sub>X</sub>	10			kΩ
$C_LXA$	Load Capacitance	GS <sub>X</sub>			50	pF
$V_OXA$	Output Dynamic Range	$GS_X$ , $R_L \ge 10 \text{ k}\Omega$	-2.8		2.8	V
$A_VXA$	Voltage Gain	VF <sub>X</sub> I <sup>+</sup> to GS <sub>X</sub>	5000			V/V
$F_UXA$	Unity Gain Bandwidth		1	2		MHz
$V_{OS}XA$	Offset Voltage		-20		20	mV
$V_{CM}XA$	Common-Mode Voltage	CMRRXA > 60 dB	-2.5		2.5	V
CMRRXA	Common-Mode Rejection Ratio	DC Test	60			dB
PSRRXA	Power Supply Rejection Ratio	DC Test	60			dB
ANALOG	INTERFACE WITH RECEIVE FILTER	(ALL DEVICES)				
RoRF	Output Resistance	Pin VF <sub>R</sub> O		1	3	Ω
$R_LRF$	Load Resistance	VF <sub>R</sub> O=±2.5V	600			Ω
$C_LRF$	Load Capacitance				500	pF
VOS <sub>R</sub> O	Output DC Offset Voltage		-200		200	mV
POWER D	ISSIPATION (ALL DEVICES)					
I <sub>CC</sub> 0	Power-Down Current	No Load (Note 2)		0.65	2.0	mA
I <sub>BB</sub> 0	Power-Down Current	No Load (Note 2)		0.01	0.33	mA
I <sub>CC</sub> 1	Power-Up (Active) Current	No Load( -40°C to 85°C)		5.0	11.0	mA
I <sub>BB</sub> 1	Power-Up (Active) Current	No Load ( -40°C to 85°C)		5.0	11.0	mA
	<del>-</del>					

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits.

Note 2:  $I_{\mbox{\footnotesize{CC0}}}$  and  $I_{\mbox{\footnotesize{BB0}}}$  are measured after first achieving a power-up state.

## **Timing Specifications**

Unless otherwise noted, limits printed in **BOLD** characters are guaranteed for  $V_{CC}$  = +5.0V ±5%,  $V_{BB}$  = -5.0V ±5%;  $T_A$  = -40°C to +85°C by correlation with 100% electrical testing at  $T_A$  = 25°C. All other limits are assured by correlation with other production tests and/or product design and characterization. All signals referenced to GNDA. Typicals specified at  $V_{CC}$  = +5.0V,  $V_{BB}$  = -5.0V,  $T_A$  = 25°C. All timing parameters are assured at  $V_{OH}$  = 2.0V and  $V_{OL}$  = 0.7V. See Definitions and Timing Conventions section for test methods information.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
$1/t_{PM}$	Frequency of Master Clocks	Depends on the Device Used and the		1.536		MHz
		BCLK <sub>R</sub> /CLKSEL Pin.		1.544		MHz
		MCLK <sub>X</sub> and MCLK <sub>R</sub>		2.048		MHz
t <sub>RM</sub>	Rise Time of Master Clock	MCLK <sub>X</sub> and MCLK <sub>R</sub>			50	ns
t <sub>FM</sub>	Fall Time of Master Clock	MCLK <sub>X</sub> and MCLK <sub>R</sub>			50	ns
t <sub>PB</sub>	Period of Bit Clock		485	488	15725	ns
t <sub>RB</sub>	Rise Time of Bit Clock	BCLK <sub>X</sub> and BCLK <sub>R</sub>			50	ns
t <sub>FB</sub>	Fall Time of Bit Clock	BCLK <sub>X</sub> and BCLK <sub>R</sub>			50	ns
t <sub>WMH</sub>	Width of Master Clock High	MCLK <sub>X</sub> and MCLK <sub>R</sub>	160			ns
t <sub>WML</sub>	Width of Master Clock Low	MCLK <sub>X</sub> and MCLK <sub>R</sub>	160			ns
t <sub>SBFM</sub>	Set-Up Time from BCLK <sub>X</sub> High	First Bit Clock after Short Frame	100			ns
	to MCLK <sub>X</sub> Falling Edge	the Leading Edge				
		of FS <sub>X</sub> Long Frame	125			
t <sub>SFFM</sub>	Setup Time from FS <sub>x</sub> High to MCLK <sub>x</sub> Falling Edge	Long Frame Only	100			ns
t <sub>WBH</sub>	Width of Bit Clock High	V <sub>IH</sub> =2.2V	160			ns
t <sub>WBL</sub>	Width of Bit Clock Low	V <sub>IL</sub> =0.6V	160			ns
t <sub>HBFL</sub>	Holding Time from Bit Clock	Long Frame Only	0			ns
	Low to Frame Sync					
t <sub>HBFS</sub>	Holding Time from Bit Clock	Short Frame Only	0			ns
	High to Frame Sync					
t <sub>SFB</sub>	Set-Up Time from Frame Sync	Long Frame Only	115			ns
	to Bit Clock Low					
t <sub>DBD</sub>	Delay Time from BCLK <sub>X</sub> High	Load=150 pF plus 2 LSTTL Loads	0		140	ns
	to Data Valid					
t <sub>DBTS</sub>	Delay Time to TS <sub>X</sub> Low	Load=150 pF plus 2 LSTTL Loads			140	ns
t <sub>DZC</sub>	Delay Time from BCLK <sub>X</sub> Low to	C <sub>L</sub> =0 pF to 150 pF	50		165	ns
	Data Output Disabled					
t <sub>DZF</sub>	Delay Time to Valid Data from	C <sub>L</sub> =0 pF to 150 pF	20		165	ns
	FS <sub>X</sub> or BCLK <sub>X</sub> , Whichever					
	Comes Later					
t <sub>SDB</sub>	Set-Up Time from D <sub>R</sub> Valid to		50			ns
	BCLK <sub>R/X</sub> Low					
t <sub>HBD</sub>	Hold Time from BCLK <sub>R/X</sub> Low to		50			ns
	D <sub>R</sub> Invalid					
t <sub>SF</sub>	Set-Up Time from FS <sub>X/R</sub> to	Short Frame Sync Pulse (1 Bit Clock	50			ns
	BCLK <sub>X/R</sub> Low	Period Long)				
t <sub>HF</sub>	Hold Time from BCLK <sub>X/R</sub> Low	Short Frame Sync Pulse (1 Bit Clock	100			ns
	to FS <sub>X/R</sub> Low	Period Long)				
t <sub>HBFI</sub>	Hold Time from 3rd Period of	Long Frame Sync Pulse (from 3 to 8 Bit	100			ns
	Bit Clock Low to Frame Sync	Clock Periods Long)				
	(FS <sub>X</sub> or FS <sub>B</sub> )					
t <sub>WFL</sub>	Minimum Width of the Frame	64k Bit/s Operating Mode	160			ns
=	Sync Pulse (Low Level)					

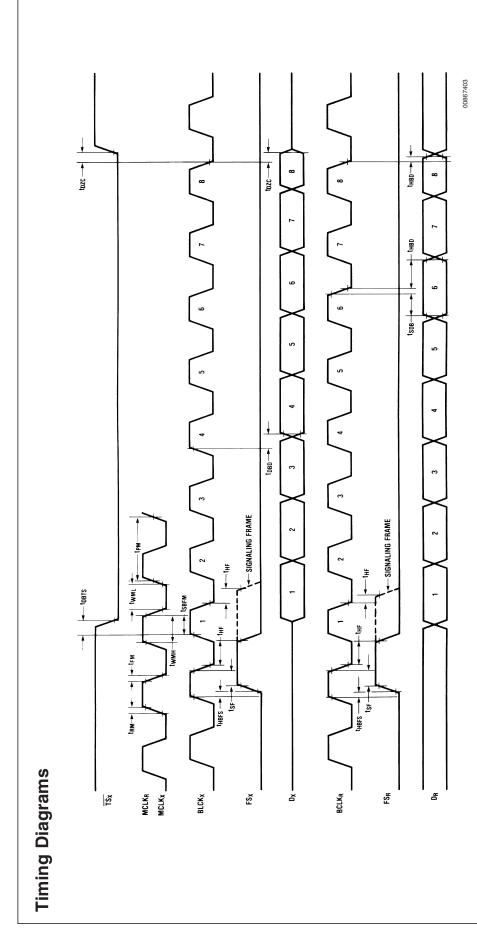
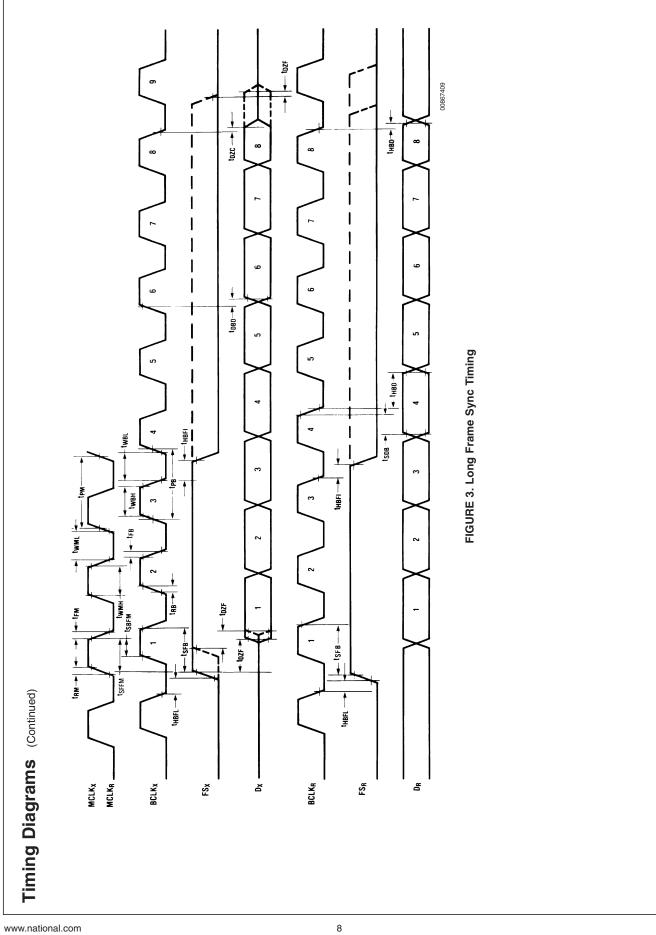


FIGURE 2. Short Frame Sync Timing



## **Transmission Characteristics**

Unless otherwise noted, limits printed in **BOLD** characters are guaranteed for  $V_{CC}$  = +5.0V ±5%,  $V_{BB}$  = -5.0V ±5%;  $T_A$  = -40°C to +85°C by correlation with 100% electrical testing at  $T_A$  = 25°C. All other limits are assured by correlation with other production tests and/or product design and characterization. GNDA = 0V, f = 1.02 kHz,  $V_{IN}$  = 0 dBm0, transmit input amplifier connected for unity gain non inverting. Typicals are specified at  $V_{CC}$  = +5.0V,  $V_{BB}$  = -5.0V,  $V_{AB}$  = 25°C.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
AMPLITU	DE RESPONSE					
	Absolute Levels	Nominal 0 dBm0 Level is 4 dBm				
	(Definition of nominal gain)	(600Ω)				
		0 dBm0		1.2276		Vrms
MAX		Max Overload Level				
		TP3054 (3.17 dBm0)		2.501		$V_{PK}$
		TP3057 (3.14 dBm0)		2.492		V <sub>PK</sub>
G <sub>XA</sub>	Transmit Gain, Absolute	T <sub>A</sub> =25°C, V <sub>CC</sub> =5V, V <sub>BB</sub> =-5V				110
701	·	Input at GS <sub>x</sub> =0 dBm0 at 1020 Hz	-0.15		0.15	dB
G <sub>XR</sub>	Transmit Gain, Relative to G <sub>XA</sub>	f=16 Hz			-40	dB
XH	The state of the s	f=50 Hz			-30	dB
		f=60 Hz			-26	dB
		f=200 Hz	-1.8		-0.1	dB
		f=300 Hz-3000 Hz	-0.15		0.15	dB
		f=3152 Hz	-0.15		0.20	dB
		f=3300 Hz	-0.15 -0.35		0.20	dB
		f=3400 Hz	-0.7		0	dB
		f=4000 Hz			-14	dB
		f=4600 Hz and Up, Measure			-32	dB
_		Response from 0 Hz to 4000 Hz				
$G_{XAT}$	Absolute Transmit Gain Variation	Relative to G <sub>XA</sub>	-0.15		0.15	dB
	with Temperature					
$G_{XAV}$	Absolute Transmit Gain Variation	Relative to G <sub>XA</sub>	-0.05		0.05	dB
	with Supply Voltage					
$G_{XRL}$	Transmit Gain Variations with	Sinusoidal Test Method				
	Level	Reference Level=-10 dBm0				
		$VF_XI^+=-40$ dBm0 to +3 dBm0	-0.2		0.2	dB
		$VF_XI^+=-50$ dBm0 to $-40$ dBm0	-0.4		0.4	dB
		$VF_XI^+=-55$ dBm0 to $-50$ dBm0	-1.2		1.2	dB
G <sub>RA</sub>	Receive Gain, Absolute	T <sub>A</sub> =25°C, V <sub>CC</sub> =5V, V <sub>BB</sub> =-5V				
		Input=Digital Code Sequence				
		for 0 dBm0 Signal at 1020 Hz	-0.20		0.20	dB
G <sub>RR</sub>	Receive Gain, Relative to G <sub>RA</sub>	f=0 Hz to 3000 Hz	-0.15		0.15	dB
nn	l l l l l l l l l l l l l l l l l l l	f=3300 Hz	-0.35		0.1	dB
		f=3400 Hz	-0.7		0	dB
		f=4000 Hz	0.7		-14	dB
G <sub>RAT</sub>	Absolute Receive Gain Variation	Relative to G <sub>BA</sub>	-0.15		0.15	dB
GRAT	with Temperature	Trelative to GRA	-0.13		0.15	uБ
	·	Deletive to C	0.05		0.05	٩D
G <sub>RAV</sub>	Absolute Receive Gain Variation	Relative to G <sub>RA</sub>	-0.05		0.05	dB
	with Supply Voltage	Oissesidel Test May 1 D (				
G <sub>RRL</sub>	Receive Gain Variations with	Sinusoidal Test Method; Reference				
	Level	Input PCM Code Corresponds to an				
		Ideally Encoded				
		PCM Level =-40 dBm0 to +3 dBm0	-0.2		0.2	dB
		PCM Level =-50 dBm0 to -40 dBm0	-0.4		0.4	dB
		PCM Level =-55 dBm0 to -50 dBm0	-1.2		1.2	dB

## **Transmission Characteristics** (Continued)

Unless otherwise noted, limits printed in **BOLD** characters are guaranteed for  $V_{CC}$  = +5.0V ±5%,  $V_{BB}$  = -5.0V ±5%;  $T_A$  = -40°C to +85°C by correlation with 100% electrical testing at  $T_A$  = 25°C. All other limits are assured by correlation with other production tests and/or product design and characterization. GNDA = 0V, f = 1.02 kHz,  $V_{IN}$  = 0 dBm0, transmit input amplifier connected for unity gain non inverting. Typicals are specified at  $V_{CC}$  = +5.0V,  $V_{BB}$  = -5.0V,  $V_{AB}$  = 25°C.

Symbol		Conditions	Min	Тур	Max	Units
	JDE RESPONSE				1	
V <sub>RO</sub>	Receive Output Drive Level	$R_L=600\Omega$	-2.5		2.5	V
	PE DELAY DISTORTION WITH FREC	T			1	
D <sub>XA</sub>	Transmit Delay, Absolute	f=1600 Hz		290	315	μs
$D_XR$	Transmit Delay, Relative to D <sub>XA</sub>	f=500 Hz-600 Hz		195	220	μs
		f=600 Hz-800 Hz		120	145	μs
		f=800 Hz-1000 Hz		50	75	μs
		f=1000 Hz-1600 Hz		20	40	μs
		f=1600 Hz-2600 Hz		55	75	μs
		f=2600 Hz-2800 Hz		80	105	μs
		f=2800 Hz-3000 Hz		130	155	μs
D <sub>RA</sub>	Receive Delay, Absolute	f=1600 Hz		180	200	μs
$D_RR$	Receive Delay, Relative to D <sub>RA</sub>	f=500 Hz-1000 Hz	-40	-25		μs
		f=1000 Hz-1600 Hz	-30	-20		μs
		f=1600 Hz-2600 Hz		70	90	μs
		f=2600 Hz-2800 Hz		100	125	μs
		f=2800 Hz-3000 Hz		145	175	μs
NOISE					•	•
N <sub>XC</sub>	Transmit Noise, C Message	TP3054		12	16	dBrnC0
	Weighted	(Note 3)				
$N_{XP}$	Transmit Noise, P Message	TP3057		-74	-67	dBm0p
	Weighted	(Note 3)				
N <sub>RC</sub>	Receive Noise, C Message	PCM Code is Alternating				
	Weighted	Positive and Negative Zero — TP3054		8	11	dBrnC0
N <sub>RP</sub>	Receive Noise, P Message	TP3057 PCM Code Equals Positive				
	Weighted	Zero —		-82	-79	dBm0p
N <sub>RS</sub>	Noise, Single Frequency	f=0 kHz to 100 kHz, Loop Around			-53	dBm0
110		Measurement, VF <sub>x</sub> I <sup>+</sup> =0 Vrms				
PPSR <sub>x</sub>	Positive Power Supply Rejection,	V <sub>CC</sub> =5.0 V <sub>DC</sub> +100 mVrms				
^	Transmit	f=0 kHz-50 kHz (Note 4)	40			dBC
NPSR <sub>X</sub>	Negative Power Supply Rejection,	V <sub>BB</sub> =-5.0 V <sub>DC</sub> + 100 mVrms				
	Transmit	f=0 kHz-50 kHz (Note 4)	40			dBC
PPSR <sub>R</sub>	Positive Power Supply Rejection,	PCM Code Equals Positive Zero				
	Receive	$V_{CC}$ =5.0 $V_{DC}$ +100 mVrms				
		Measure VF <sub>B</sub> 0				
		f=0 Hz-4000 Hz	38			dBC
		f=4 kHz-25 kHz	38			dB
		f=25 kHz-50 kHz	35			dB
NPSR <sub>R</sub>	Negative Power Supply Rejection,	PCM Code Equals Positive Zero	33			ub
MI OHR	Receive	$V_{BB}$ =-5.0 $V_{DC}$ +100 mVrms				
	1 IECEIVE					
		Measure VF <sub>R</sub> 0	20			dPC
		f=0 Hz-4000 Hz	38			dBC
		f=4 kHz-25 kHz	38			dB
		f=25 kHz-50 kHz	35			dB

## **Transmission Characteristics** (Continued)

Unless otherwise noted, limits printed in **BOLD** characters are guaranteed for  $V_{CC}$  = +5.0V ±5%,  $V_{BB}$  = -5.0V ±5%;  $T_A$  = -40°C to +85°C by correlation with 100% electrical testing at  $T_A$  = 25°C. All other limits are assured by correlation with other production tests and/or product design and characterization. GNDA = 0V, f = 1.02 kHz,  $V_{IN}$  = 0 dBm0, transmit input amplifier connected for unity gain non inverting. Typicals are specified at  $V_{CC}$  = +5.0V,  $V_{BB}$  = -5.0V,  $T_A$  = 25°C.

Symbol	Parameter	Parameter Conditions				Max	Units
NOISE			•				
SOS	Spurious Out-of-Band Signals	Loop Around Measurement, 0 of	dBm0,			-30	dB
	at the Channel Output	300 Hz to 3400 Hz Input PCM	Code				
		Applied at D <sub>R</sub> .					
		4600 Hz-7600 Hz				-30	dB
		7600 Hz-8400 Hz				-40	dB
		8400 Hz-100,000 Hz				-30	dB
DISTORT	TON						
$STD_{X,}$	Signal to Total Distortion	Sinusoidal Test Method (Note 6	6)				
$STD_R$	Transmit or Receive	Level=3.0 dBm0		33			dBC
	Half-Channel	=0 dBm0 to -30 dBm0		36			dBC
		=-40 dBm0	XMT	28			dBC
			RCV	29			dBC
		=-55 dBm0	XMT	13			dBC
			RCV	14			dBC
$SFD_X$	Single Frequency Distortion,					-43	dB
	Transmit						
$SFD_R$	Single Frequency Distortion,					-43	dB
	Receive						
IMD	Intermodulation Distortion	Loop Around Measurement,				-41	dB
		$VF_XI^+=-4$ dBm0 to $-21$ dBm0,	Two				
		Frequencies in the Range					
		300 Hz-3400 Hz					
CROSST	ALK						
CT <sub>X-R</sub>	Transmit to Receive Crosstalk,	f=300 Hz-3400 Hz			-90	-70	dB
	0 dBm0 Transmit Level	D <sub>R</sub> =Quiet PCM Code (Note 6)					
CT <sub>R-X</sub>	Receive to Transmit Crosstalk,	f=300 Hz-3400 Hz, VF <sub>X</sub> I=Multit	tone		-90	-70	dB
	0 dBm0 Receive Level	(Note 4)					

## **ENCODING FORMAT AT D<sub>x</sub> OUTPUT**

	TP3054									TP3	8057					
	μ-Law									A-l	_aw					
					(Inc	ludes	Ever	n Bit I	nvers	ion)						
V <sub>IN</sub> (at GS <sub>x</sub> )=+Full-Scale	1	0	0	0	0	0	0	0	1	0	1	0	1	0	1	0
V <sub>IN</sub> (at GS <sub>x</sub> )=0V	1	1	1	1	1	1	1	1	1	1	0	1	0	1	0	1
	0	1	1	1	1	1	1	1	0	1	0	1	0	1	0	1
V <sub>IN</sub> (at GS <sub>X</sub> )=-Full-Scale	0	0	0	0	0	0	0	0	0	0	1	0	1	0	1	0

Note 3: Measured by extrapolation from the distortion test result at -50 dBm0.

Note 4:  $PPSR_X$ ,  $NPSR_X$ , and  $CT_{R-X}$  are measured with a -50 dBm0 activation signal applied to  $VF_XI^+$ .

Note 5: TP3054/57 are measured using C message weighted filter for μ-law and psophometric weighted filter for A-law.

Note 6:  $CT_{X-R}$  @ 1.544 MHz MCLK $_X$  freq. is -70 dB max. 50%  $\pm 5\%$  BCLK $_X$  duty cycle.

## **Applications Information**

#### **POWER SUPPLIES**

While the pins of the TP3050 family are well protected against electrical misuse, it is recommended that the standard CMOS practice be followed, ensuring that ground is connected to the device before any other connections are made. In applications where the printed circuit board may be plugged into a "hot" socket with power and clocks already present, an extra long ground pin in the connector should be used

All ground connections to each device should meet at a common point as close as possible to the GNDA pin. This minimizes the interaction of ground return currents flowing through a common bus impedance. 0.1  $\mu\text{F}$  supply decoupling capacitors should be connected from this common ground point to  $V_{\text{CC}}$  and  $V_{\text{BB}},$  as close to device pins as possible.

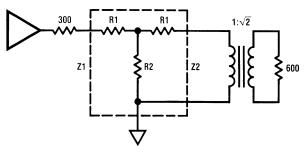
For best performance, the ground point of each CODEC/FILTER on a card should be connected to a common card ground in star formation, rather than via a ground bus.

This common ground point should be decoupled to  $\rm V_{\rm CC}$  and  $\rm V_{\rm BB}$  with 10  $\rm \mu F$  capacitors.

#### **RECEIVE GAIN ADJUSTMENT**

For applications where a TP3050 family CODEC/filter receive output must drive a  $600\Omega$  load, but a peak swing lower than  $\pm 2.5V$  is required, the receive gain can be easily adjusted by inserting a matched T-pad or  $\pi$ -pad at the output. Table 2 lists the required resistor values for  $600\Omega$  terminations. As these are generally non-standard values, the equations can be used to compute the attenuation of the closest practical set of resistors. It may be necessary to use unequal values for the R1 or R4 arms of the attenuators to achieve a precise attenuation. Generally it is tolerable to allow a small deviation of the input impedance from nominal while still maintaining a good return loss. For example a 30 dB return loss against  $600\Omega$  is obtained if the output impedance of the attenuator is in the range  $282\Omega$  to  $319\Omega$  (assuming a perfect transformer).

#### **T-Pad Attenuator**



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$$\begin{aligned} \text{R1} &= \text{Z1} \left( \frac{\text{N}^2 + 1}{\text{N}^2 - 1} \right) - 2\sqrt{\text{Z1.Z2}} \left( \frac{\text{N}}{\text{N}^2 - 1} \right) \\ \text{R2} &= 2\sqrt{\text{Z1.Z2}} \left( \frac{\text{N}}{\text{N}^2 - 1} \right) \\ \text{Where: N} &= \sqrt{\frac{\text{POWER IN}}{\text{POWER OUT}}} \end{aligned}$$

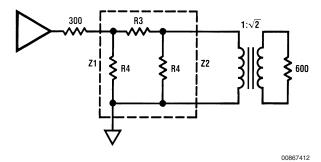
$$S = \sqrt{\frac{Z1}{Z2}}$$

Also: 
$$Z = \sqrt{Z_{SC} \cdot Z_{OC}}$$

Where  $Z_{SC}=$  impedance with short circuit termination and  $Z_{OC}=$  impedance with open circuit termination

# Applications Information (Continued)

#### $\pi$ -Pad Attenuator



Note: See Application Note 370 for further details.

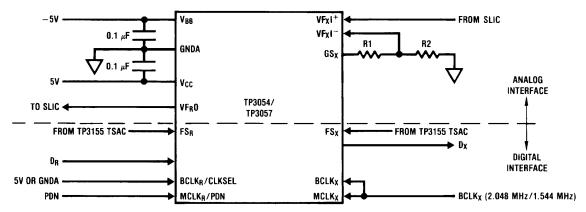
$$R3 = \sqrt{\frac{Z1.Z2}{2}} \left( \frac{N^2 - 1}{N} \right)$$

$$R3 = Z1 \left( \frac{N^2 - 1}{N^2 - 2NS + 1} \right)$$

TABLE 2. Attentuator Tables for Z1=Z2=300 $\Omega$  (All Values in  $\Omega$ )

	`	· · · · · · · · · · · · · · · · · · ·		
dB	R1	R2	R3	R4
0.1	1.7	26k	3.5	52k
0.2	3.5	13k	6.9	26k
0.3	5.2	8.7k	10.4	17.4k
0.4	6.9	6.5k	13.8	13k
0.5	8.5	5.2k	17.3	10.5k
0.6	10.4	4.4k	21.3	8.7k
0.7	12.1	3.7k	24.2	7.5k
0.8	13.8	3.3k	27.7	6.5k
0.9	15.5	2.9k	31.1	5.8k
1.0	17.3	2.61	34.6	5.2k
2	34.4	1.3k	70	2.6k
3	51.3	850	107	1.8k
4	68	650	144	1.3k
5	84	494	183	1.1k
6	100	402	224	900
7	115	380	269	785
8	379	284	317	698
9	143	244	370	630
10	156	211	427	527
11	168	184	490	535
12	180	161	550	500
13	190	142	635	473
14	200	125	720	450
15	210	110	816	430
16	218	98	924	413
18	233	77	1.17k	386
20	246	61	1.5k	366

# **Typical Synchronous Application**



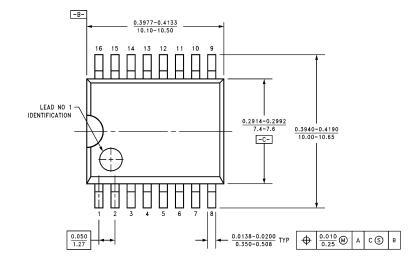
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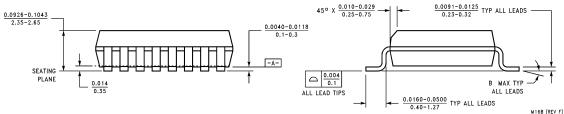
Note 1: XMIT gain = 20 
$$\times$$
 log  $\left(\frac{R1+R2}{R2}\right)$  ,(R1+R2)  $>$  10 K $\Omega$ .

FIGURE 4.

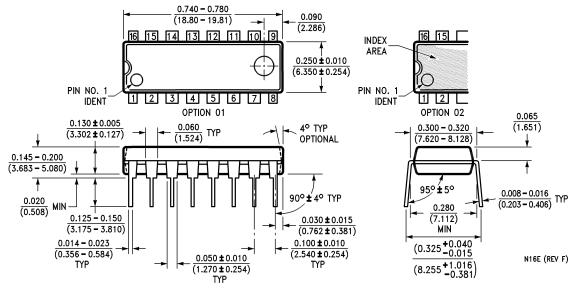
## Physical Dimensions inches (millimeters)

unless otherwise noted



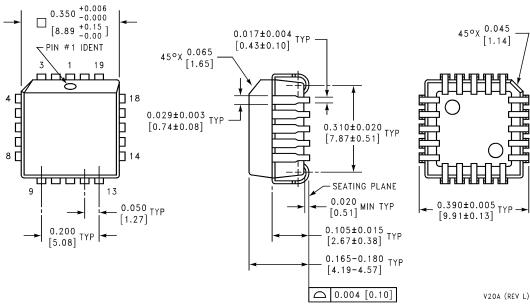


Dual-In-Line Package (M) Order Number TP3054WM-X NS Package Number M16B



Molded Dual-In-Line Package (N) Order Number TP3054N-X NS Package Number N16E

## Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Cavity Dual-In-Line Package (V) Order Number TP3057V-X NS Package Number V20A

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